## **Supporting information for**

# Substrate Effects on Structural and Optoelectronic Properties of Quasi-2D Perovskite Films

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#### **Experimental section**

*Materials:* PEN substrates were purchased from Peccell Technologies, Inc., PDMS substrates were purchased from Dow Corning Corp. Methylammonium iodide (MAI) and lead iodide (PbI<sub>2</sub>) were purchased from Xi'an Polymer Light Technology Corp, 2-phenylethylamine hydroiodide (PEAI) was purchased from Liaoning Preferred New Energy Technology Corp. The organic solvents include dimethyl sulfoxide (DMSO, 99.9%), chlorobenzene (CB, 99.9%) were purchased from Sigma Aldrich. All reagents and chemicals were used as received without further purification.

*Perovskite precursor solutions:* 0.8 mmol of  $PbI_2$ , 0.6 mmol of MAI, 0.4 mmol of PEAI were dissolved in 1.2 ml of a mixed solution of DMF and DMSO (9:1 volume ratio). The prepared quasi 2D perovskite precursor solution was stirred at 50°C for 12 hours. Care was taken to store it away from light using a brown bottle. Prior to spin-coating, the solution was filtered through a 0.22 µm polytetrafluoroethylene (PTFE) needle filter tip into a clear white bottle to obtain a clear, yellow solution of the perovskite precursor.

Sample preparation and device fabrication: Silicon, glass, PEN, and PDMS substrates were first meticulously cleaned through ultrasonic washing in distilled water, isopropanol, and ethanol, followed by treatment with UV-ozone plasma to enhance surface properties. In order to avoid large movement and deformation of the flexible substrate and maintain a stable temperature during the film preparation process, the flexible PEN and PDMS substrates are supported by rigid glass substrate. The PEN substrate is fixed on the glass by double-sided tape, and the PDMS substrate is directly attached to the glass due to its good adhesion. These prepared substrates were subsequently coated with a perovskite precursor solution using a spin-coating technique. The process involved heating the substrate on a hotplate at 100°C for 3 minutes to ensure proper adhesion and film formation. This was followed by a precisely controlled spin-coating step at a speed of 4000 rpm for 30 seconds. A volume of 90  $\mu$ L of the perovskite precursor solution was accurately dispensed onto the substrate using a pipette, and immediately after the spin-coating process, the substrate was transferred to a hotplate set at 100°C for annealing over 10 minutes to crystallize the film. The fabrication of the devices was finalized by depositing 80 nm thick gold electrodes through thermal evaporation under a high vacuum of 5 × 10<sup>-5</sup> Pa at a deposition rate of 0.1 Å/s, establishing the electrical contacts. The active area of the resulting vertical structure devices was meticulously defined to be 0.038 mm<sup>2</sup>.

*Device characterization:* Grazing incidence wide-angle X-ray scattering (GIWAXS) analyses of the films were performed using a Xeuss 2.0 system from Xenocs, France, with a wavelength of 1.54189 Å and an incident angle of 0.3°. X-ray diffraction (XRD) measurements were conducted using a Smart Lab 3kW X-ray diffractometer. The films' surface morphologies were examined via scanning electron microscopy (SEM) using a Zeiss EVO 18 SEM. Absorption spectra were acquired with a Shimadzu UV-2600 spectrophotometer. Steady-state and time-resolved photoluminescence (TRPL) measurements were conducted using a Fluorolog-3 fluorescence spectrophotometer from Horiba Scientific. The photoluminescence quantum yield (PLQY) of the thin films was determined using a SpectrumTEQ-EL electroluminescence quantum efficiency

measurement system (Ocean Optics) under 375 nm excitation. The current-voltage (*I-V*) characteristics of the devices were recorded with a Keysight B2912A source meter. Low-temperature PL spectroscopy and *I-V* measurements were performed using a cryostat system in conjunction with a Fluorolog-3 fluorescence spectrophotometer and a Keysight B2912A source meter, respectively.

## **Supplementary Figures**



**Figure S1.** XRD patterns of quasi-2D perovskite films deposited on four different substrates, indexed by the (110) plane.



**Figure S2.** SEM images of perovskite on four different substrates, magnification at (a) 500x and (b) 10000x.



**Figure S3.** Grain size distribution in quasi-2D perovskite films on four different substrates, as derived from SEM images.



**Figure S4.** UV-vis absorption spectra of quasi-2D perovskites deposited on glass, PEN, and PDMS substrates.



**Figure S5.** PL spectra of quasi- 2D perovskites on four substrates measured at various temperatures.



**Figure S6.** Variation of perovskite peak energy, corresponding to 3D-like phases, with temperature for quasi-2D perovskites on four substrates.



**Figure S7**. Cross-sectional SEM image of a quasi-2D perovskite film prepared using the described experimental method.



**Figure S8.** Variation of conductivity with temperature for Au/perovskite/Au vertical structure devices on four different substrates.



Figure S9. *I-V* curve of Au/perovskite/Au lateral device on silicon substrate.



**Figure S10.** Variation of conductivity with temperature for Au/perovskite/Au lateral structure devices on four different substrates.

### **Supplementary Table**

**Table S1:** Determination of time constants in PL decay kinetics through tri-exponential fitting of TRPL spectra.

| Substrate | t <sub>1</sub> (ns) | t2(ns) | t3(ns) | $A_1$ | <b>A</b> <sub>2</sub> | <b>A</b> 3 | taver(ns) |
|-----------|---------------------|--------|--------|-------|-----------------------|------------|-----------|
| Si        | 17.0                | 564.7  | 1.8    | 124   | 264                   | 255        | 235.7     |
| Glass     | 32.6                | 521.6  | 1.5    | 67    | 65                    | 236        | 99.4      |
| PEN       | 14.8                | 782.6  | 1.6    | 54    | 221                   | 228        | 346.1     |
| PDMS      | 23.6                | 342.9  | 1.7    | 35    | 112                   | 270        | 95.7      |